

A

B

C

D

E

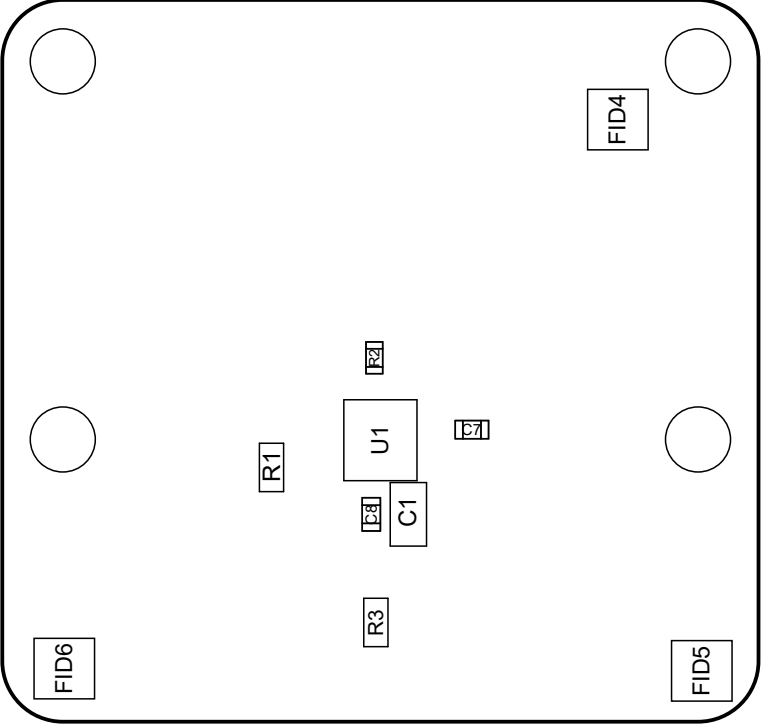
ASSEMBLY NOTES:

Assembly shall conform to IPC-A-610 Class 2.
Assembly shall conform with RoHS Directive 2011/65/EU.
Components shall be placed according to the associated CPL and BOM documents.
Lead-free SAC305 solder shall be used.
Reflow profile shall comply with J-STD-20C Lead-Free Reflow Profile.
BGA components shall be 100% checked with x-ray for solder bridges after reflow.
Finished assemblies shall be removed from panel prior to delivery.

Notes:

- 1
- 2
- 3

[Variant:]: View from Bottom side (Scale 4:1)



Title: PA0960	
Number: D0000999	Revision: R0M0 E0
Date: 26. 06. 2023	Sheet: 1 of 2
Drawn by: Primož Ambrozic	



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A

B

C

D

E

A

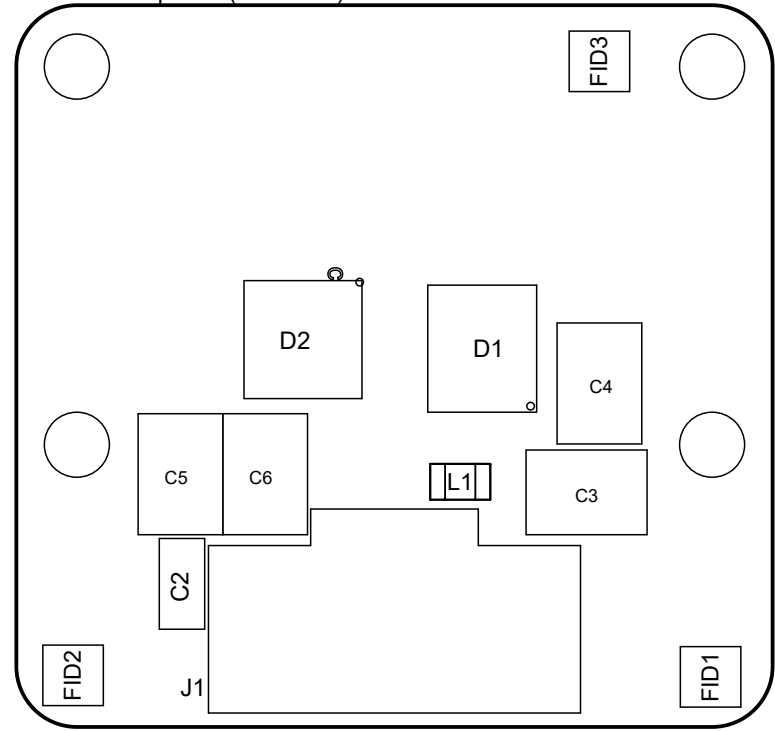
B


C

D

E

View from Top side (Scale 4:1)



Title: PA0960		
Number: D0000999	Revision: R0M0 E0	
Date: 26. 06. 2023 Sheet: 2 of 2		PROPRIETARY AND CONFIDENTIAL
Drawn by: Primoz Ambrozic		THE INFORMATION CONTAINED IN THIS DRAWING IS THE SOLE PROPERTY OF LUXONIS HOLDING CORPORATION. ANY REPRODUCTION IN PART OR AS A WHOLE WITHOUT THE WRITTEN PERMISSION IS PROHIBITED.

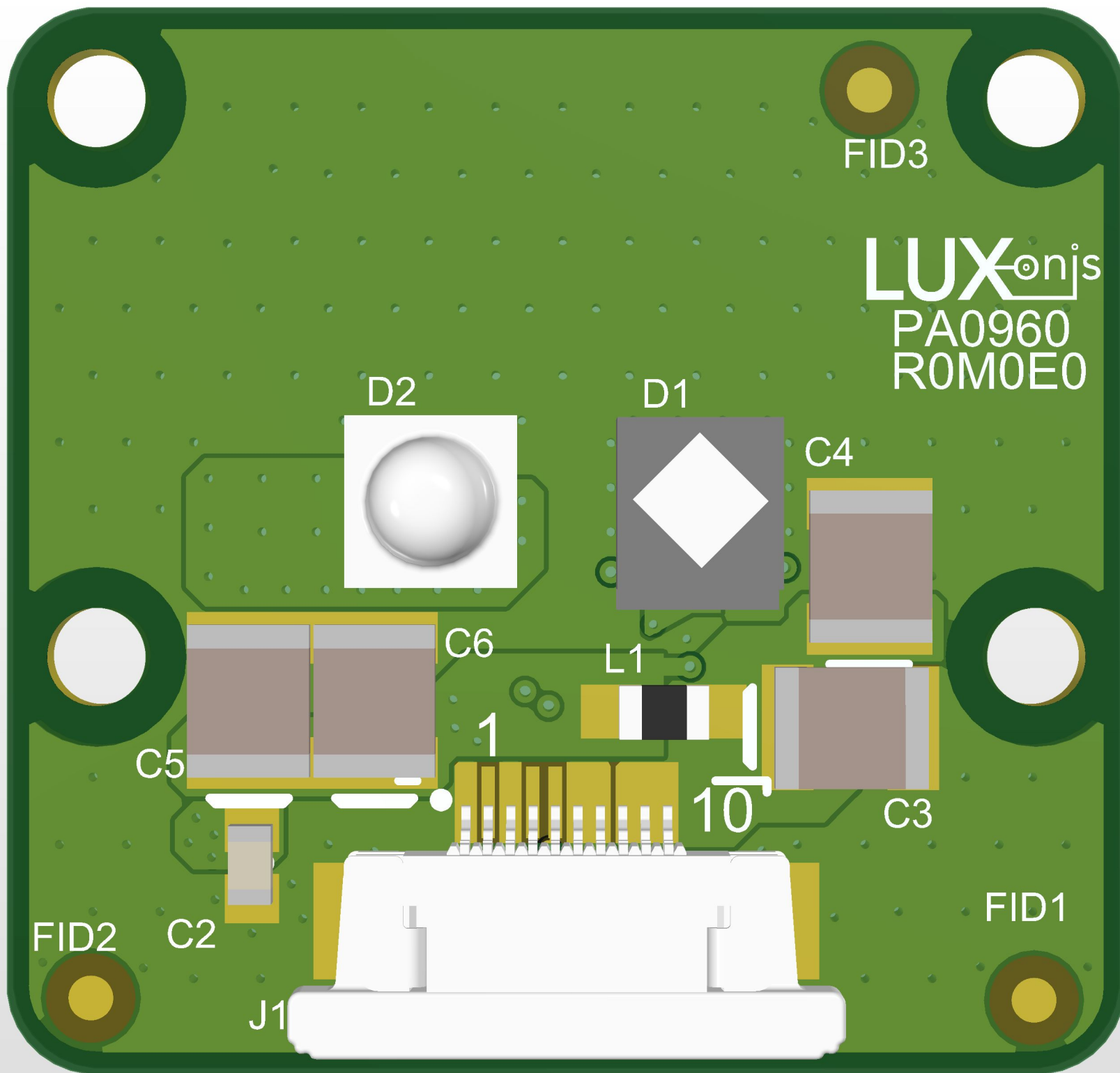
A

B

C

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E

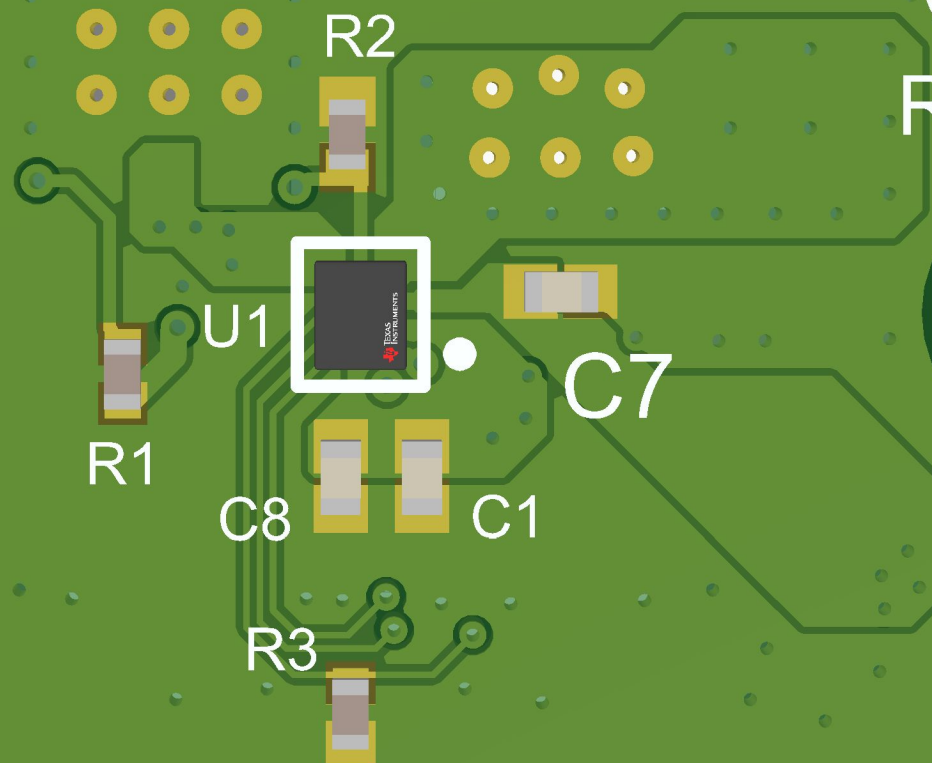


LUXonis

PA0960
ROM0E0

FID4

Pb
RoHS



FID6

FID5